



Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
-20V	8mΩ@-4.5V	-40A
	10mΩ@-2.5V	

Feature

- Trench Technology Power MOSFET
- Low $R_{DS(on)}$
- Low Gate Charge
- Low Gate Resistance
- 100% UIS Tested
- 100% ΔV_{DS} Tested

Application

- Power Switching Application

MARKING:

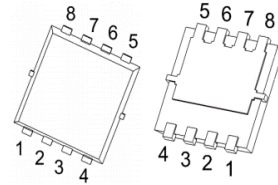


M080P02U = Device Code
 XX = Date Code
 Solid Dot = Green Indicator

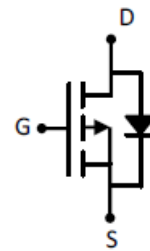
ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain - Source Voltage	V_{DS}	-20	V
Gate - Source Voltage	V_{GS}	± 12	V
Continuous Drain Current ^{1,5}	I_D	$T_A = 25^\circ\text{C}$	-40
		$T_A = 100^\circ\text{C}$	-26
Pulsed Drain Current ²	I_{DM}	-160	A
Single Pulsed Avalanche Current ³	I_{AS}	-31	A
Single Pulsed Avalanche Energy ³	E_{AS}	200	mJ
Power Dissipation ^{4,5}	P_D	3.2	W
Thermal Resistance from Junction to Case ⁵	$R_{\theta JC}$	39	$^\circ\text{C/W}$
Junction Temperature	T_J	150	$^\circ\text{C}$
Storage Temperature	T_{STG}	-55~ +150	$^\circ\text{C}$

PDFN3.3X3.3-8L



Schematic diagram



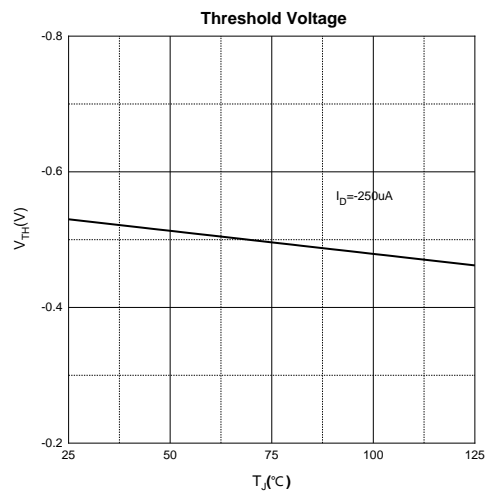
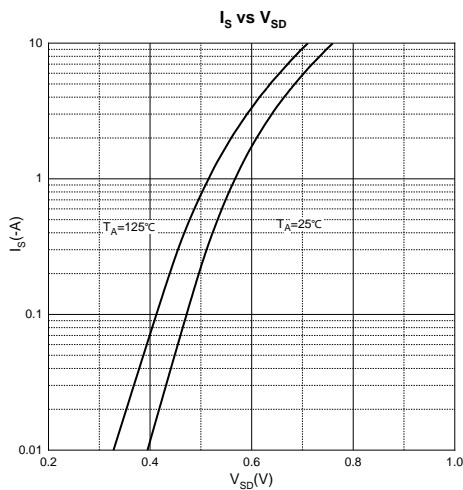
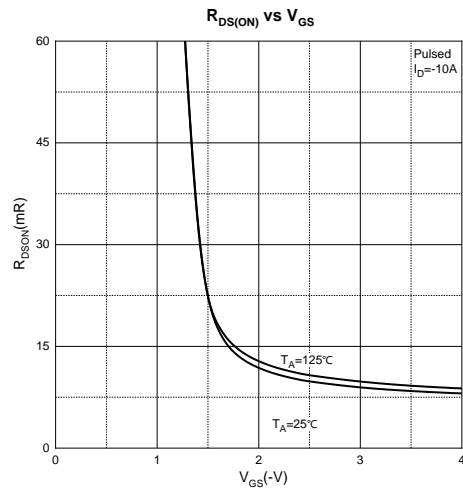
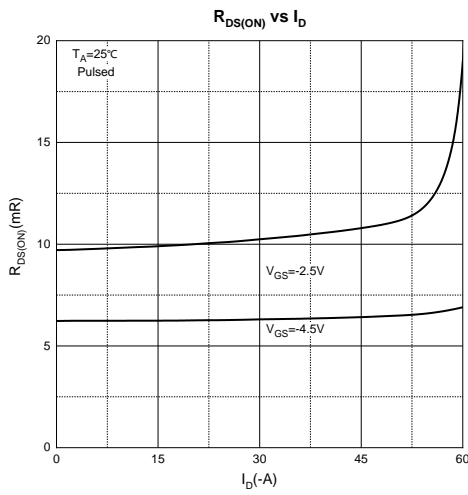
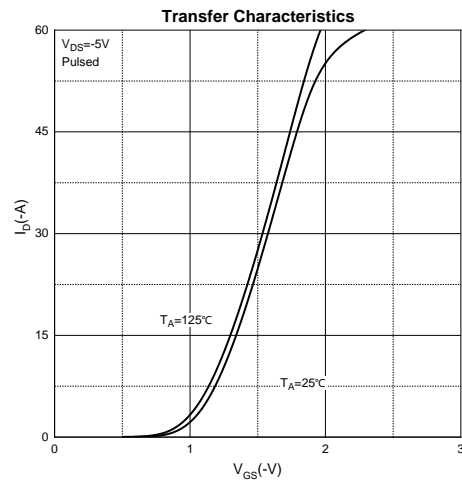
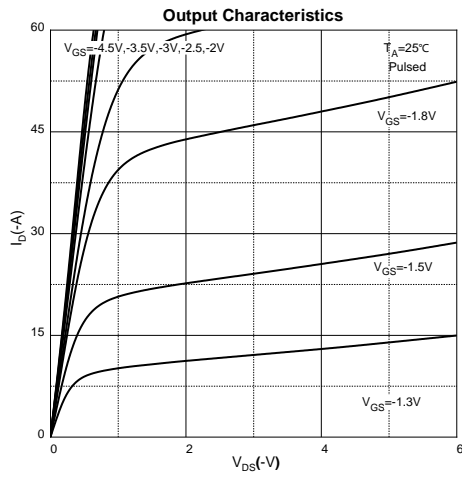
MOSFET ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Off Characteristics						
Drain - Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = -250μA	-20			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -20V, V _{GS} = 0V			-1	μA
Gate - Body Leakage Current	I _{GSS}	V _{GS} = ±12V, V _{DS} = 0V			±100	nA
On Characteristics³						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250μA	-0.4	-0.6	-1.0	V
Drain-source On-resistance	R _{DS(on)}	V _{GS} = -4.5V, I _D = -10A		8	11	mΩ
		V _{GS} = -2.5V, I _D = -10A		10	13	
Dynamic Characteristics						
Input Capacitance	C _{iss}	V _{DS} = -10V, V _{GS} = 0V, f = 1MHz		4536		pF
Output Capacitance	C _{oss}			521		
Reverse Transfer Capacitance	C _{rss}			465		
Gate Resistance	R _g	V _{DS} = 0V, V _{GS} = 0V, f = 1MHz		14		Ω
Switching Characteristics						
Total Gate Charge	Q _g	V _{DS} = -15V, V _{GS} = -4.5V, I _D = -10A		49.7		nC
Gate-source Charge	Q _{gs}			5.7		
Gate-drain Charge	Q _{gd}			13.7		
Turn-on Delay Time	t _{d(on)}	V _{DD} = -10V, V _{GS} = -10V, I _D = -13A, R _G = 2.7Ω		10		ns
Turn-on Rise Time	t _r			110		
Turn-off Delay Time	t _{d(off)}			155		
Turn-off Fall Time	t _f			160		
Source - Drain Diode Characteristics						
Diode Forward Voltage ³	V _{SD}	V _{GS} = 0V, I _S = -10A			-1.2	V

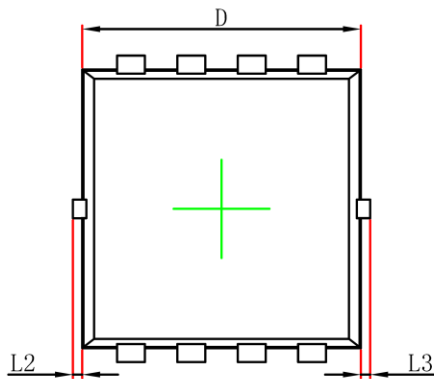
Notes :

- 1.The maximum current rating is limited by package.
- 2.Pulse Test : Pulse Width ≤ 10μs, duty cycle ≤ 1%.
- 3.Pulse Test : Pulse Width ≤ 300μs, duty cycle ≤ 2%.
- 4.The power dissipation P_D is limited by T_{J(MAX)} = 150°C.
- 5.Device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C.

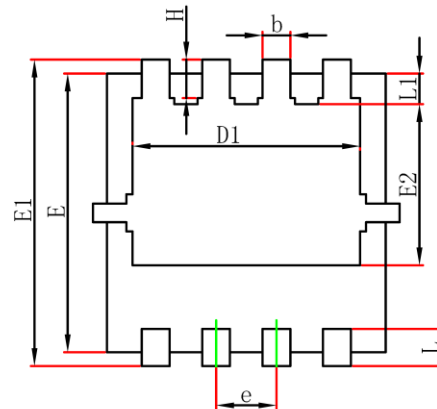
Typical Characteristics



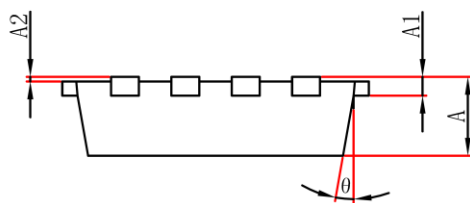
PDFN3.3X3.3-8L Package Information



Top View
[顶视图]



Bottom View
[背视图]



Side View
[侧视图]

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.700	0.900	0.028	0.035
A1	0.152REF		0.006REF	
A2	0.000	0.050	0.000	0.002
D	2.900	3.200	0.114	0.126
D1	2.300	2.600	0.091	0.102
E	2.900	3.200	0.114	0.126
E1	3.150	3.450	0.124	0.136
E2	1.535	1.935	0.060	0.076
b	0.200	0.400	0.008	0.016
e	0.550	0.750	0.022	0.030
L	0.300	0.500	0.012	0.020
L1	0.180	0.480	0.007	0.019
L2	0.000	0.100	0.000	0.004
L3	0.000	0.100	0.000	0.004
H	0.315	0.515	0.012	0.020
θ	0°	12°	0°	12°